

To our customers,

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## Old Company Name in Catalogs and Other Documents

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## Precautions on Using the H8S/2556 E6000 Emulator

Thank you for purchasing the H8S/2556 E6000 emulator.

Please note the followings when using this version of the H8S/2556 E6000 emulator.

### 1 Precautions on Using the Emulator

#### 1.1 Memory Mapping

When using the H8S/2556 platform, emulator memory and user memory cannot be mapped in each of address area blocks listed below at the same time. If this is attempted, the previously mapped area will be changed into a guarded area.

Block name	Address area	Block name	Address area
SB0	H'000000-H'01FFFF	LB0	H'100000-H'1FFFFFFF
SB1	H'020000-H'03FFFF	LB1	H'200000-H'3FFFFFFF
SB2	H'040000-H'05FFFF	LB2	H'400000-H'5FFFFFFF
SB3	H'060000-H'07FFFF	LB3	H'600000-H'7FFFFFFF
SB4	H'080000-H'09FFFF	LB4	H'800000-H'9FFFFFFF
SB5	H'0A0000-H'0BFFFF	LB5	H'A00000-H'BFFFFFFF
SB6	H'0C0000-H'0DFFFF	LB6	H'C00000-H'DFFFFFFF
SB7	H'0E0000-H'0FFFFFFF	LB7	H'E00000-H'FFFFFFF

#### 1.2 Voltage Follower Circuit

When setting the Vccdown detection voltage in the voltage follower circuit, make the setting be at least 2.7V or higher.

#### 1.3 Event

##### 1.3.1 Combination of Address-Range and Data Compare-Byte

When an address range is set as the address condition and byte data as the data condition, a break will occur only at even addresses in the address range. When an address range is set as the address condition, do not set an odd address as the Address Lo condition. Otherwise, a break will not occur even when the conditions are satisfied.

##### 1.3.2 Removing Software Breakpoints during Execution of the User Program

Do not remove Software breakpoints in the source window, [Disassembly] window, or [Label] window during execution of the user program.

##### 1.3.3 Recovery of Software Breakpoints by the Session File

Information on Software breakpoints that was saved in the session file is not available until a load module is loaded. If necessary, load a load module or set new Software breakpoints.

#### 1.4 Display of the Memory Content and Operation of Memory

##### 1.4.1 Operating Memory during Execution of the User Program

The memory copy, memory compare, memory fill, and memory test functions are not available during execution of the user program. These command lines are not available either.

## 1.4.2 Memory Test

- **Memory Content after Execution of a Memory Test**  
The content of memory in the specified range after execution of a memory test will not be guaranteed. The contents of windows that display memory, such as the [Memory] window, are not automatically updated after a memory test. Be careful if you want to continue debugging.
- **MT Command**  
When an incorrect parameter has been specified for the MT command, the command line window may display the message “UNKNOWN ERROR –nnnnnnnnnn”. Enter the correct parameter. The command line window displays the message “Open this document” after ending the MT command. Ignore this message because it is not concerned with the result of the MT command.

## 1.4.3 Updating the Memory Content during Execution of the User Program

Updating the content of the [Memory] window during execution of the user program when either of the following conditions is satisfied causes the displayed values to be incorrect:

- [Enable read and write on the fly] in the [Configuration Properties] dialog box has been disabled
- Stepping (step-in, step-over, or step-out) is being performed
- The emulator is in sleep mode, software standby mode, watch mode, or subsleep mode.

In those cases, the correct values will be displayed when the content of the window is updated after the program has stopped. This also applies to the windows [Disassembly], [Image View], [IO], [Watch], and [Waveform].

Updating of the [Monitor] window or [Watch] window by reading values with the monitoring function is available even with those conditions.

## 1.4.4 MEMORY\_MOVE Command

Do not select the V/N option in the MEMORY\_MOVE command. Writing to memory by the MEMORY\_MOVE command always requires verification.

## 1.5 The Load/Save of File

### 1.5.1 Access Size of Download Modules

When you specify a download module for debug settings, do not select 4 or 8 for [Access size] in the [Download Module] dialog box.

### 1.5.2 Loading a File in the SYSROF Format

No program in the SYSROF format can be loaded. Any program for debugging must be created in the Elf/Dwarf2 format.

### 1.5.3 FILE\_LOAD Command

Do not specify V in the FILE\_LOAD command. Use the FILE\_VERIFY command to verify memory.

### 1.5.4 FILE\_SAVE Command

The content of memory cannot be saved in the Elf/Dwarf2 format.

## 1.6 Emulation

### 1.6.1 Temporary Breakpoints

- **Run... (Run menu)**  
Do not set temporary breakpoints to an area wherein Software Break (User Read-only) cannot be set. Otherwise, user program execution will not stop at the breakpoint. Moreover, the On Chip Breakpoint may remain. In this case, delete the breakpoint from the [Breakpoints] window.

### **1.6.2 Rate of Stepping**

- To perform stepping continuously with the [Image View] or [Waveform] window open, do not select “0 seconds” as the delay.
- Do not perform stepping continuously if you have specified the realtime update of the [Image] or [Waveform] window.

### **1.6.3 Go to Cursor**

The [Go to Cursor] function uses one Software breakpoint. Note the followings:

- To use the [Go to Cursor] function, the number of Software breakpoints must be 255 or less.
- To use the [Go to Cursor] function for the ROM area on the target system, do not use the On Chip Breakpoint by the Software break.

### **1.6.4 Note on Occurrence of Breaks**

When a break occurs during execution of the user program with a dialog box open, the state of High-performance Embedded Workshop may not transit to the breaking state. In this case, close the dialog box and select [Halt Program] from the [Debug] menu or press the [Halt Program] button on the toolbar. You can check whether a break has occurred or not by the RUN lamp (LED) on the emulator station. The RUN lamp (LED) is illuminated while the user program is running.

### **1.6.5 Execution Status Display**

- Execution Status Display on Status Bar  
At memory access wait, not the address where the access is halted, but the next fetched address is displayed.

### **1.6.6 Source-Level Execution**

- Step  
Even standard C libraries are executed. To return to a higher-level function, enter Step Out. In a for statement or a while statement, executing a single step does not move execution to the next line. To move to the next line, execute two steps. Do not execute a step on a sleep instruction.

## **1.7 The Load/Save of the Session File**

Load the file after you confirm that the H/W environment is the same as that when the last session file was loaded.

Note that the operation of High-performance Embedded Workshop may become incorrect when Target Clock is chosen at the time when the session file was saved and the target clock was not supplied at the time when the session file was loaded.

## **1.8 Assembling and Disassembling**

### **1.8.1 Line Assembly**

- Input Radix  
Regardless of the Radix setting, the default for line assembly input is decimal. Specify H' or 0x as the radix for a hexadecimal input.
- Address Space Size  
In absolute addressing mode, specify the size (:16, etc.)

## **1.9 Note on [Register] Window Operation during Program Execution**

During program execution, when the [Register] window is double-clicked, a dialog box to change the register contents is displayed. However, the operation to change the register contents is invalid during program execution.

## **1.10 [IO] Window**

### **1.10.1 Contents of the [IO] Window**

The invalid module display and bit information display in the [IO] window are not supported.

## 1.11 Source File

### 1.11.1 Note on Moving Source File Position after Creating Load Module

When the source file is moved after the load module has been created, the [Open] dialog box, which specifies the source file, may be displayed during debugging of the created load module. Select the corresponding source file.

### 1.11.2 Columns in the Source Window

The columns Event and EXT.2 Trigger in the source window may be switched. You can identify these columns by displaying a popup menu on either of them.

### 1.11.3 Event Column

When different actions have been set on an address from the windows [Event] and [Trace], note the followings:

- Deletion and change for settings may not be available on the [Event] column.
- If eight or more points have been set as the start points in execution time measurement (Timer On), changing the settings on the [Event] column may prevent further changes.

Deletion and change for settings must be made in the [Event] window or [Trace] window.

## 1.12 Watch

### 1.12.1 Local Variables at Optimization

Depending on the generated object code, local variables in a C source file that is compiled with the optimization option enabled will not be displayed correctly. Check the generated object code by displaying the [Disassembly] window.

### 1.12.2 Variable Name Specification

When a name other than a variable name, such as a symbol name or a function name, is specified, no data is displayed.

### 1.12.3 Display of float- and double-type Variables

Do not enable the automatic update of float- and double-type variables. The values of float- and double-type variables will not be correctly displayed if they are automatically updated during execution of the user program. If you want to check the values, use the monitoring function ([Monitor] window).

### 1.12.4 Synchronization with the [Monitor] window

The content of the [Watch] window will be undefined if you change the monitor settings in the [Monitor] window during execution of the user program while the [Monitor] window is used to monitor the addresses of the symbols registered in the [Watch] window.

### 1.13 Command Line Interface

- **Specifying a File**  
If a file is specified in the relative path format for a command line parameter, an access to the file may not be available. A file must be specified in the absolute path format when using a command line.
- **Batch File**  
If the message “Not currently available” is displayed while executing a batch file, enter the sleep command. Adjust the length of sleep time since it varies according to the operating environment.  
Example: When “Not currently available” is displayed during memory\_fill execution:  
    sleep d'3000  
    memory\_fill 0 ffff 0
- **Overwrite File**  
In Command Line Interface, a file that has the same name as the output file is overwritten without asking the user.
- **Log File**  
To change the target platform due to a change of the session while logging of the command line window, halt logging.
- **GO\_TILL Command**  
If the GO\_TILL command executed by specifying “wait” as the parameter is terminated with an error, the command processing may not be available. In such cases, select [Stop] in the popup menu of the command line window to perform the command processing.

### 1.14 Monitoring Function

#### 1.14.1 Changing Monitor Settings during User Program Execution

If you change the monitor settings in the [Monitor] window during execution of the user program, the initial values will be undefined.

### 1.15 Installation and Uninstallation

#### 1.15.1 Uninstallation from [Tool Administration]

Note that a message dialog box appears for confirmation if the folder to be removed includes a file other than those installed. Even though this dialog box is displayed, press the [Ignore] button to continue uninstallation.

#### 1.15.2 [Add/Remove Programs Properties] of the Control Panel

Note the followings:

- Uninstalling from [Add/Remove Programs Properties] of the control panel only removes folders and files of the product most recently installed if several products that conform to High-performance Embedded Workshop have been installed. Use the explorer to remove the folders and files of the rest of the products.
- Once uninstallation is attempted, even products that were not removed may not operate correctly. If you want to use these products, re-install them.

#### 1.15.3 Usage with Other Products

To install the SuperH™ RISC engine C/C++ compiler package or H8S, H8/300 series C/C++ compiler package after installing the E6000 emulator software for High-performance Embedded Workshop, select [High-performance Embedded Workshop] as the component to be installed in [Select Components] during installation of the compiler package.

## 2 User's Manual

### 2.1 Emulator User's Manual

In the E6000 emulator user's manual, some screen bitmap may be different from actual ones.